

T-1 3/4 (5mm) FULL COLOR LED LAMP



ATTENTION **OBSERVE PRECAUTIONS** FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Part Number: L-154A4SUREQBFZGEC

Hyper Red Blue Green

Features

- Uniform light output.
- Low power consumption.
- Long life-solid state reliability.
- RoHS compliant.

Description

The Hyper Red source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode.

The Blue source color devices are made with InGaN Light Emitting Diode.

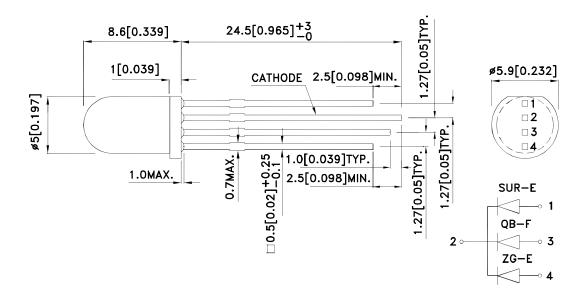
The Green source color devices are made with InGaN Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25(0.01") unless otherwise noted.
- Lead spacing is measured where the leads emerge from the package.
 The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
L-154A4SUREQBFZGEC	Hyper Red (AlGaInP)	Water Clear	650	1300	- 50°
			*200	*400	
	Blue (InGaN)		400	900	
			*400	*900	
	Green (InGaN)		2200	3600	
			*2200	*3600	

Notes:

- 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red Blue Green	645 460 520		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper Red Blue Green	630 465 525		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red Blue Green	25 25 35		nm	IF=20mA
С	Capacitance	Hyper Red Blue Green	45 100 100		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red Blue Green	1.9 3.3 3.2	2.5 4 4	V	IF=20mA
lr	Reverse Current	Hyper Red Blue Green		10 50 50	uA	Vr=5V

Notes:

- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

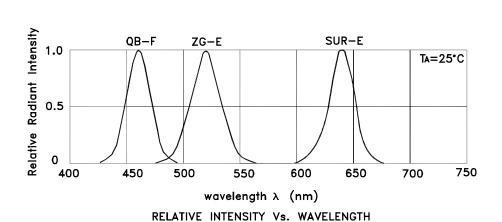
Absolute Maximum Ratings at TA=25°C

Parameter	Hyper Red	Blue	Green	Units		
Power dissipation	75	120	120	mW		
DC Forward Current	30	30	30	mA		
Peak Forward Current [1]	200	150	100	mA		
Reverse Voltage	5 V					
Operating/Storage Temperature	-40°C To +85°C					
Lead Solder Temperature [2]	260°C For 3 Seconds					
Lead Solder Temperature [3]	260°C For 5 Seconds					

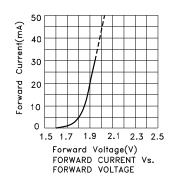
- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
 2. 2mm below package base.
 3. 5mm below package base.

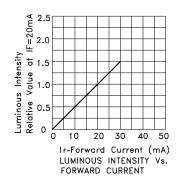
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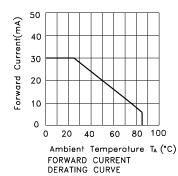
^{*}Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

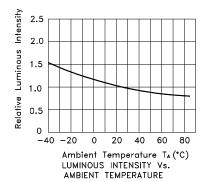


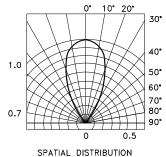
L-154A4SUREQBFZGEC Hyper Red









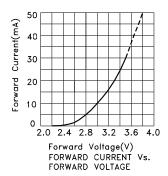


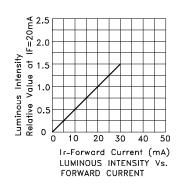
SI ATIAL DISTRIBUTION

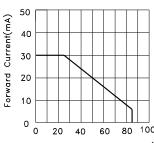
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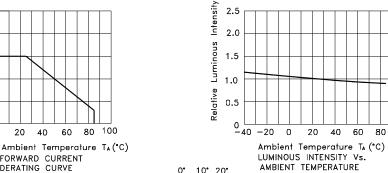
Blue





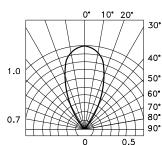


FORWARD CURRENT DERATING CURVE



2.5

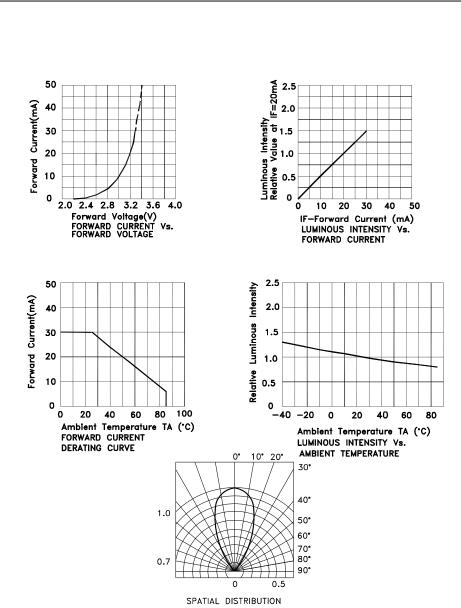
2.0



SPATIAL DISTRIBUTION

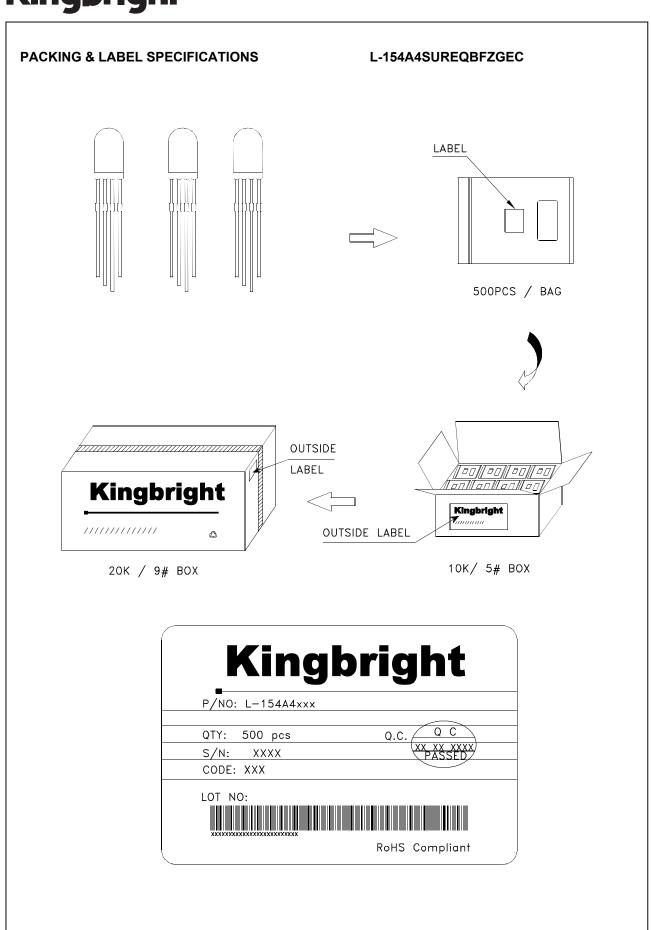
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Green



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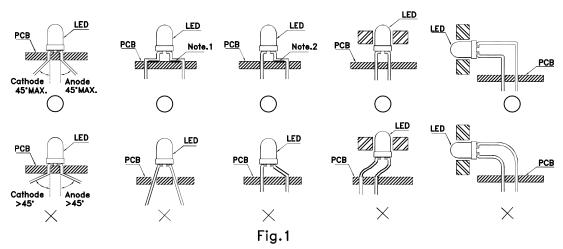
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PRECAUTIONS

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead—forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures. (Fig. 1)



- "() " Correct mounting method "imes" Incorrect mounting method
- 2. When soldering wire to the LED, use individual heat—shrink tubing to insulate the exposed leads to prevent accidental contact short—circuit. (Fig.2)
- 3. Use stand—offs (Fig.3) or spacers (Fig.4) to securely position the LED above the PCB.

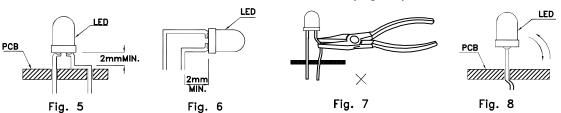


- 4. Maintain a minimum of 2mm clearance between the base of the LED lens and the first lead bend. (Fig. 5 and 6)
- 5. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB. (Fig. 7)

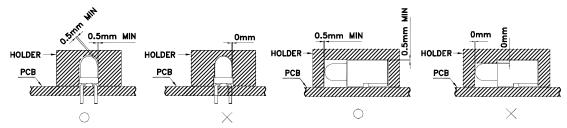
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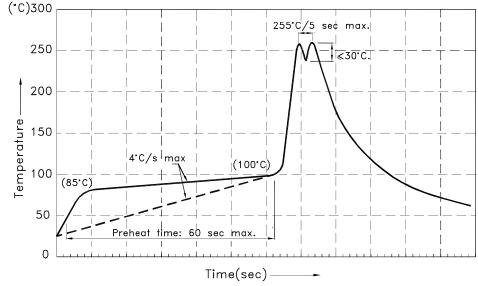
6. Do not bend the leads more than twice. (Fig. 8)



7. During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.



- 8. The tip of the soldering iron should never touch the lens epoxy.
- 9. Through—hole LEDs are incompatible with reflow soldering.
- 10. If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.
- 11. Recommended Wave Soldering Profiles:



Notes:

- 1.Recommend pre—heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
- 2.Peak wave soldering temperature between 245°C \sim 255°C for 3 sec (5 sec max).
- 3.Do not apply stress to the epoxy resin while the temperature is above 85°C.
- 4.Fixtures should not incur stress on the component when mounting and during soldering process.
- 5.SAC 305 solder alloy is recommended.
- 6.No more than one wave soldering pass.

Detailed application notes are listed on our website.

http://www.kingbright.com/application notes

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